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Demonstration of High-speed Hysteresis-free Negative Capacitance in Ferroelectric $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$

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Abstract—We report the experimental observation of hysteresis-free negative capacitance (NC) in thin ferroelectric $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$ (HZO) films through high-speed pulsed charge-voltage measurements. Hysteretic switching is suppressed by the addition of thin Al_2O_3 layers on top of the HZO to prevent the screening of the polarization. We observe an S-shaped polarization-electric field dependence without hysteresis in agreement with Landau theory, which enables direct extraction of NC modeling parameters for ferroelectric HZO. Hysteresis-free NC is demonstrated down to 100 ns pulse widths limited only by our measurement setup. These results give critical insights into the physics of ferroelectric NC and practical NC device design using ferroelectric HZO.

I. INTRODUCTION

To overcome the fundamental limits of power dissipation in nanoscale transistors due to the minimum subthreshold swing $S > 60$ mV/dec at room temperature, several new device concepts have been proposed, e.g. the tunnel-FET and the negative capacitance (NC) FET [1]. The latter is based on the idea that ferroelectric materials exhibit an S-shaped polarization-electric field (P - E) dependence, which implies a region of NC (i.e. $C_F < 0$) without hysteresis according to Landau theory (see the red line in Fig. 1). However, in typical ferroelectric devices, large hysteresis and only positive capacitance $C_F > 0$ is observed as shown in the blue line in Fig. 1. To obtain the S-shaped P - E curve, it is necessary to add a dielectric (or semiconducting) layer in contact to the ferroelectric, to prevent the immediate screening of its spontaneous polarization P_S [2]. For hysteresis-free operation, the capacitance C_D of this dielectric layer must be matched to the ferroelectric NC region ($C_D < |C_F|$), see Fig. 1. The most promising ferroelectrics for NCFET applications are HfO_2 and ZrO_2 based materials due to their full CMOS process compatibility and high scalability [3]. Especially the equal mixture of $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$ (HZO) shows good ferroelectric properties even for thinner films and lower thermal budget integration. While NCFETs with $S < 60$ mV/dec and without hysteresis have been demonstrated using DC measurements [4], all reports of faster or even pulsed measurements have shown considerable hysteresis so far. Therefore, an unambiguous demonstration of hysteresis-free NC in HZO even during fast pulsed operation (which corresponds to the actual operating condition in a digital circuit) is urgently needed. To experimentally show this, here we fabricated capacitors using ferroelectric HZO with and without dielectric Al_2O_3 layers on top. We also varied the thickness of both HZO and Al_2O_3 layers to investigate the scalability of the

NC effect as well as capacitance mismatch ($C_D > |C_F|$) and charge trapping, which can give rise to undesirable hysteresis. By using a pulsed charge-voltage (Q - V) measurement approach [5], we can distinguish between NC and hysteretic switching and examine the speed limits of hysteresis-free NC in HZO. Furthermore, from the pulsed Q - V data we can reconstruct the S-shaped P - E curve and thus directly extract the Landau parameters for HZO, which are crucial for accurate NCFET device modeling.

II. EXPERIMENTAL

Metal-ferroelectric-metal (MFM) and metal-ferroelectric-insulator-metal (MFIM) capacitors were fabricated on Si substrates. TiN bottom electrodes of 12 nm thickness were reactively sputtered in a BESTEC physical vapor deposition tool at room temperature. Subsequently, 7.7 nm and 11.3 nm thin HZO films were grown by atomic layer deposition (ALD) in an Oxford Instruments OpAL ALD tool at 260 °C using the precursors TEMA-Hf, and TEMA-Zr with water as an oxidant. For MFIM samples, ALD of 0.5 nm to 4 nm Al_2O_3 was carried out directly after HZO deposition without breaking vacuum using TMA and water as precursors also at 260 °C. The film thicknesses were adjusted by varying the number of ALD cycles. TiN top electrodes were deposited in the same way as the bottom electrodes. The HZO layers were then crystallized by 600 °C annealing for 20 s in N_2 atmosphere. Capacitor pads were defined by evaporating 10 nm Ti and 30 nm Pt through a shadow mask. These Pt dots ($\sim 7000 \mu\text{m}^2$) served as a hard mask during the wet etch (NH_4OH , H_2O_2 , and H_2O solution) of the TiN top electrode. Similarly, TiN/ Al_2O_3 /TiN reference capacitors were fabricated to extract the relative permittivity $\epsilon_r = 8$ of the Al_2O_3 . X-ray reflectometry and grazing-incidence X-ray diffraction (GIXRD) measurements were carried out on a Bruker D8 Discover (Cu- $K\alpha$ radiation, $\lambda = 0.154$ nm) for structural analysis of the samples. Transmission electron microscopy (TEM) analysis was carried out on a Zeiss Libra 200 TEM. Electrical measurements were performed on a Cascade Microtech Probe Station with a Keithley 4200 SCS with a 4225-PMU and remote amplifier, an HP 8110A pulse generator and a Tektronix TDS7154B digital oscilloscope. Standard polarization-electric field hysteresis was measured by applying triangular voltage signals with 10 kHz frequency. Capacitance-voltage measurements were carried out using a small-signal amplitude of 50 mV and a frequency of 10 kHz. For pulsed charge-voltage measurements, capacitors were connected to the pulse generator while measuring the current and voltage via the oscilloscope with a 50 Ω and 1 M Ω input impedance, respectively.

III. RESULTS AND DISCUSSION

To confirm ferroelectricity in our HZO films we first used GIXRD to determine their crystalline structure. As shown in Fig. 2, both 7.7 nm and 11.3 nm thin HZO films mainly consist of the ferroelectric orthorhombic phase. The electrical measurements of the fabricated MFM capacitors in Fig. 3 show excellent ferroelectric properties with coercive fields of ~ 1 MV/cm and a high remanent polarization P_r of up to $27 \mu\text{C}/\text{cm}^2$ after 10^5 electric field cycles. Furthermore, symmetric butterfly-shaped capacitance-field characteristics (Fig. 4) and only small P_r changes with electric field cycling are observed (Fig. 5). To investigate the NC behavior of these HZO layers, we fabricated and characterized MFIM structures with dielectric Al_2O_3 layers of 0.5 nm to 4 nm thickness. Fig. 6 shows a TEM cross-section of an MFIM capacitor with 7.7 nm HZO and 4 nm Al_2O_3 to confirm the thickness of the individual layers. In the higher resolution TEM cross-section in Fig. 7, the polycrystalline nature of the HZO layer in contrast to the amorphous structure of Al_2O_3 can be seen. For all combinations of layer thicknesses (7.7 nm/11.3 nm HZO and 0.5–4 nm Al_2O_3) we carried out small-signal capacitance measurements to look for a capacitance enhancement $C > C_D$, which would indirectly prove NC in the HZO layer. The inverse capacitances C^{-1} are plotted as a function of the Al_2O_3 thickness in Fig. 8. As can be seen, no small-signal capacitance enhancement is observed for the MFIM layers. In fact, the HZO and Al_2O_3 layers behave exactly as two positive capacitors in series where $C^{-1} = C_D^{-1} + C_F^{-1}$. This means that no stabilized NC is observed in these structures, which seems to be related to fixed charges at the HZO/ Al_2O_3 interface that screen the remanent polarization when no voltage is applied [5]. Therefore, pulsed Q - V measurements were necessary to access the ferroelectric NC region during switching. Using a pulse generator and oscilloscope, the applied voltage and current flowing were measured (see setup in Fig. 9), from which the charge on the capacitor was calculated. Fig. 10 shows the results of such a pulsed measurement on a 11.3 nm HZO/4 nm Al_2O_3 capacitor: In (a) the applied voltage waveform V_1 is shown with a pulse width of ~ 500 ns and increasing amplitude. In (b), the measured current I is shown during charging and discharging of the capacitor. From the integration of I , the charge is obtained, and maximum, released and residual charges are defined in Fig. 10(c) as Q_{max} , Q_D and Q_{res} , respectively. These charges are plotted against the maximum applied voltage $V_{1,\text{max}}$ in Fig. 10(d). Note that the released charge Q_D for higher voltages is larger than the charge expected for a 4 nm Al_2O_3 layer only, which means that the capacitance of the HZO layer C_F must be negative in this region [5]. The field in the HZO layer is given by $E_F = (V_{1,\text{max}} - Q_D/C_D - RI)/t_F$, where R is the resistance and t_F the ferroelectric thickness. If we plot E_F as a function of $Q_D \approx P$, we obtain the HZO P - E_F curve shown in Fig. 11. A region of NC is observed which starts for positive applied pulses V_1 around the coercive field of ~ 1 MV/cm. For negative applied pulses, only a linear dielectric response is observed, which shows that the HZO is initially in the negative P_r state due to compensating charges at the HZO/ Al_2O_3 interface. Using Landau theory ($E_F = 2\alpha P_S + 4\beta P_S^3$ and $Q_D = \epsilon_0\epsilon_b E_F + P_S \approx P$),

we obtain an excellent agreement to the experimental data ($\alpha = -8.8 \cdot 10^8$ m/F, $\beta = 1.3 \cdot 10^{10}$ m⁵/(C²F) and $\epsilon_b = 25$). Note that the $P_r \approx 18 \mu\text{C}/\text{cm}^2$ is in good agreement with the values in Fig. 5 for the pristine sample. To confirm that this NC effect is hysteresis-free, we applied 500 ns ascending and descending pulses to the MFIM samples with 4 nm Al_2O_3 which is shown in Fig. 12. Fig. 13 shows the extracted P - E_F curve for the 7.7 nm HZO sample, which confirms the absence of hysteretic switching. Again, Landau theory can nicely fit the measured results ($\alpha = -1.1 \cdot 10^9$ m/F, $\beta = 2.5 \cdot 10^{10}$ m⁵/(C²F) and $\epsilon_b = 25$). To investigate hysteresis as a function of Al_2O_3 thickness, we repeated the experiment for the other MFIM samples. As exemplarily shown in Fig. 14, for 1 nm Al_2O_3 and 7.7 nm HZO, a hysteresis in the Q_D - $V_{1,\text{max}}$ characteristics emerges which is related to the capacitance mismatch $C_D > |C_F|$ of both layers. The maximum Q_D -hysteresis ΔQ_D is plotted as a function of the Al_2O_3 thickness in Fig. 15. For Al_2O_3 layers thinner than ~ 1.8 nm, $C_D > |C_F|$ which results in a large hysteresis. For 2–3 nm Al_2O_3 thickness (where $C_D < |C_F|$) we observe a transition region which might be related to some mismatched domains and/or charge trapping. Only for the 4 nm Al_2O_3 sample, negligible hysteresis is observed since all domains are matched and charge trapping is completely inhibited. To investigate the speed of NC in HZO, we shortened the pulse widths down to 100 ns, where we still observed NC effects without hysteresis as shown in Fig. 16. For future work, investigations on the relation between fundamental switching kinetics [6] and NC observed in HfO_2 based ferroelectrics will be of interest. Lastly, Fig. 17 compares all hysteresis-free NC reports of MFIM devices from literature. While prior works used thicker perovskite ferroelectrics, this work demonstrates the superior scalability of HfO_2 based materials with the additional advantage of full CMOS process compatibility.

IV. CONCLUSIONS

Hysteresis-free NC in HZO/ Al_2O_3 stacks has been demonstrated down to 100 ns short pulsed voltage operation. S-shaped P - E curves for direct fitting of Landau coefficients were extracted. For thinner Al_2O_3 films, increased hysteresis was observed. These results highlight pathways towards fast and hysteresis-free NC devices for digital applications.

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Fig. 1. Polarization-electric field (P - E) dependence of a ferroelectric based on Landau theory. Without dielectric, hysteresis and only positive capacitance C_F is expected while with dielectric, no hysteresis and negative capacitance (NC) $C_F < 0$ is achieved, if the dielectric capacitance C_D is matched in the NC region, i.e. $C_D < |C_F|$ (see green load line of the dielectric).

Fig. 2. Grazing-incidence X-ray diffraction patterns of ferroelectric HZO layers of different thickness compared to reference patterns for common phases in HfO_2 . The HZO films are mostly orthorhombic.

Fig. 3. Experimental P - E hysteresis curves measured at 10 kHz for TiN/HZO/TiN capacitors with different HZO thicknesses after wake-up cycling (10^5 cycles at 100 kHz).

Fig. 4. Capacitance-electric field hysteresis for different HZO thicknesses measured at the frequency $f = 10$ kHz and 50 mV small-signal amplitude after wake-up cycling (10^5 cycles at 100 kHz).

Fig. 5. Evolution of remanent polarization P_r with electric field cycling ($f = 100$ kHz) for different HZO thicknesses.

Fig. 6. Transmission electron microscope (TEM) cross-section of an Al_2O_3 /HZO capacitor structure with about 4 nm Al_2O_3 and 7.7 nm HZO.

Fig. 7. High-resolution TEM of the 4 nm Al_2O_3 and 7.7 nm HZO capacitor. The polycrystalline structure of HZO and amorphous phase of the Al_2O_3 layer can be seen.

Fig. 8. Inverse small-signal capacitance C ($f = 10$ kHz, 50 mV amplitude) for different HZO and Al_2O_3 thicknesses. Solid blue and red lines show linear fits and the green line corresponds to the theoretical capacitance of Al_2O_3 without HZO.

Fig. 9. Schematic sample structure and experimental setup for pulsed charge-voltage measurements. Short voltage pulses are applied to the top electrode while the current is measured through the 50Ω input resistance of an oscilloscope. The pulse voltage is measured at the same time.

Fig. 10. (a) Applied voltage pulses with increasing amplitude. (b) Measured current during charging and discharging of the 11.3 nm HZO/4 nm Al₂O₃ capacitor. (c) Charge on the capacitor as a function of time t integrated from the current in (b). (d) Maximum, released and residual charges (Q_{max} , Q_D and Q_{res}) as a function of maximum applied voltage. Black line shows expected charge for 4 nm Al₂O₃ layer without HZO.

Fig. 12. Pulsed charge-voltage hysteresis measurement for capacitors with 4 nm Al₂O₃. No hysteresis is observed for ascending and descending voltage pulse trains with 500 ns pulse width.

Fig. 13. Extracted P - E curve for 7.7 nm HZO with 4 nm Al₂O₃ from Fig. 12. No hysteresis is observed in the S-shaped curve in accordance with fundamental Landau theory.

Fig. 11. Ferroelectric P - E curve of 11.3 nm HZO with 4 nm Al₂O₃ extracted from the pulsed charge-voltage measurements in Fig. 10. Initially, the ferroelectric is in the negative remanent state with $P_r \approx -18 \mu\text{C}/\text{cm}^2$. For negative applied pulses, only a linear dielectric response is observed, since the HZO is already switched to negative polarization. However, for positive applied pulses, the ferroelectric enters the NC region corresponding to the negative slope of the S-shaped Landau P - E curve.

Fig. 14. Pulsed charge-voltage measurement for a capacitor with only 1 nm Al₂O₃. Hysteresis is observed due to capacitance mismatch. ΔQ_D is defined as the maximum Q_D hysteresis.

Fig. 15. Maximum hysteresis as a function of layer thicknesses. For Al₂O₃ layers thicker than 3 nm, no hysteresis is observed in the pulsed charge-voltage measurements with pulse widths of 500 ns. The transition region is due to partial domain mismatch and/or charge trapping effects.

Fig. 16. Shortest applied pulses of 100 ns still show hysteresis-free NC in the 11.3 nm HZO/4 nm Al₂O₃ sample. Applying even shorter pulses was not possible due to the RC -delay of the measurement setup ($RC \approx 30$ ns).

Fig. 17. Comparison of hysteresis-free negative capacitance in ferroelectric/dielectric capacitors reported in literature. Besides this work, all other reports applied perovskite-based ferroelectrics which are not CMOS compatible. Additionally, HZO is much more scalable compared to perovskite ferroelectrics.